### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)TYP</sub>	l <sub>D</sub>
1001/	8.5mΩ@10V	60A
100V	12mΩ@4.5V	OUA



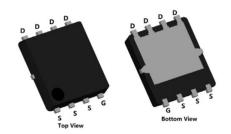
#### **Feature**

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

## **Applications**

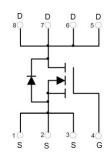
- Power switching application
- Battery management
- Uninterruptible power supply

### **Package**

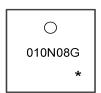


PDFN5X6-8L

#### Circuit diagram



#### Marking



010N08G : Product code \* : Month code

#### **Order Information**

Device	Package	Unit/Tape	
SP010N08GNK	PDFN5X6-8L	5000	



## Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current (Tc=25°C)	I <sub>D</sub>	60	А
Continuous Drain Current (Tc=100°C)	I <sub>D</sub>	40	А
Pulsed Drain Current	I <sub>DM</sub>	240	А
Single Pulse Avalanche Energy <sup>1</sup>	Eas	173	mJ
Power Dissipation (Tc=25°C)	P <sub>D</sub>	89	W
Thermal Resistance Junction-to-Case	R <sub>θJC</sub>	1.4	°C/W
Storage Temperature Range	T <sub>STG</sub>	55 to 150	$^{\circ}$ C
Operating Junction Temperature Range	TJ	55 to 150	$^{\circ}$ C

## Electrical characteristics (Ta=25°C, unless otherwise noted)

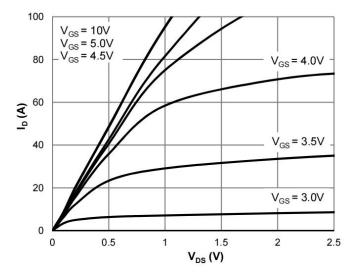
Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit	
Static Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V	
Drain Cut-Off Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V	-	-	1	uA	
Gate Leakage Current	I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±0.1	nA	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	1.0	1.9	2.5	V	
Dusin Course ON Desistance	D	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	8.5	11	mQ	
Drain-Source ON Resistance	R <sub>DS(ON)</sub>	$V_{GS} = 4.5V, I_D = 15A$	-	12	16	] 11177	
Dynamic Characteristics		-					
Input Capacitance	Ciss		-	1635	-		
Output Capacitance	Coss	$V_{DS}$ =50V, $V_{GS}$ = 0V, f = 1.0MHz	-	339	-	pF	
Reverse Transfer Capacitance	Crss		-	22	-		
Total Gate Charge	Qg		-	14	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =50V , VGS=10V , ID=50A	-	5	-		
Gate-Drain Charge	$Q_{gd}$		-	7	-		
Switching Characteristics							
Turn-On Delay Time	t <sub>d(on)</sub>		-	8	-		
Rise Time	tr	V <sub>GS</sub> = 10V, V <sub>DS</sub> =50V, ID=50A	-	16	-	20	
Turn-Off Delay Time	$t_{d(off)}$	$R_G = 4.7\Omega$	-	31	-	nS	
Fall Time	t <sub>f</sub>		-	27	-		
Drain-Source Body Diode Characteris	stics						
Source-Drain Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃	-	-	1.2	V	
Maximum Body-Diode Continuous Current	Is		-	-	60	А	
Reverse Recovery Time	Trr		-	49	-	nS	
Reverse Recovery Charge	Qrr	l <sub>S</sub> =20A, di/dt=100A/us, T <sub>J</sub> =25℃	-	78	-	nC	

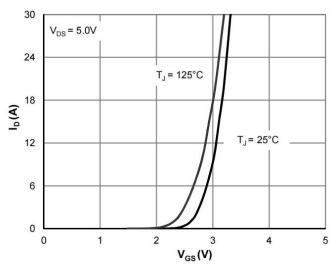
#### Note:

1. The EAS test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25Q



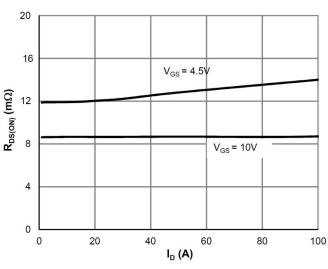
#### **Typical Characteristics**

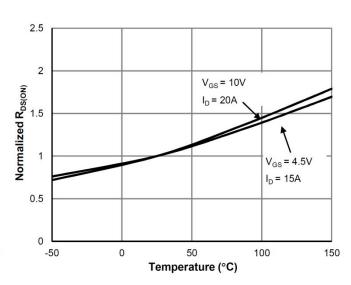




**Typical Output Characteristics** 

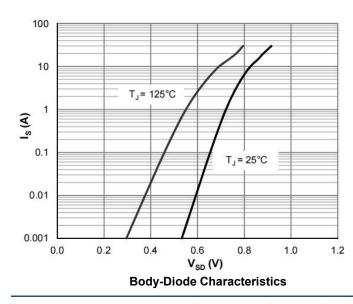


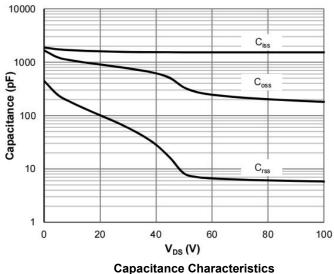


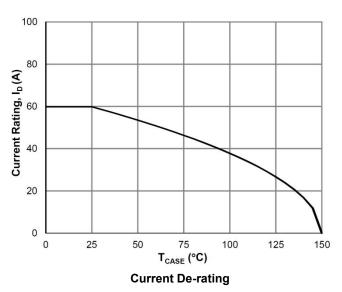


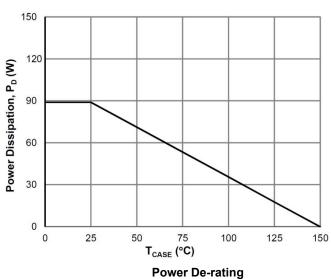
**On-Resistance vs.Drain Current** 

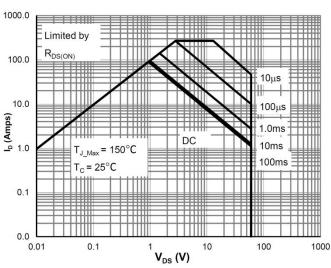
**On-Resistance vs. Junction Temperature** 

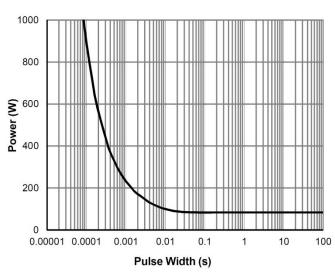






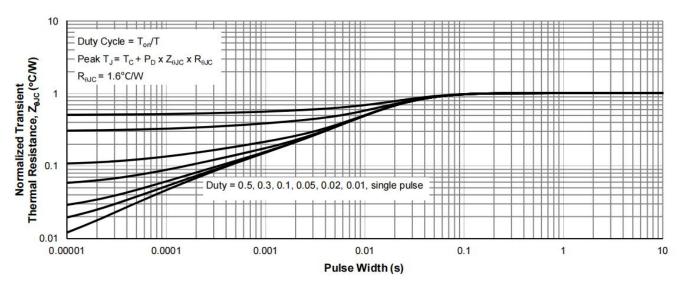






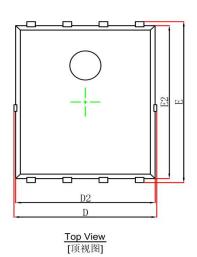
**Maximum Safe Operating Area** 

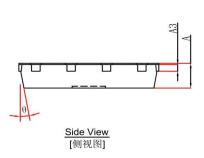
Single Pulse Power Rating, Junction-to-Case

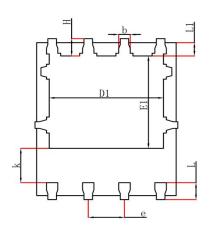


**Normalized Maximum Transient Thermal Impedance** 

# PDFN5X6-8L Package Information







Bottom View [背视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	0.900	1.000	0.035	0.039	
А3	0.254	0.254REF.		REF.	
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	3.910	4.110	0.154	0.162	
E1	3.375	3.575	0.133	0.141	
D2	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
е	1.270	1.270TYP.		TYP.	
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	10°	12°	10°	12°	